Darlington Transistors

NPN Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CES}	30	Vdc
Collector-Base Voltage	V _{CB}	40	Vdc
Collector – Emitter Voltage	V _{EB}	10	Vdc
Collector Current – Continuous	۱ _C	1.0	Adc
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	P _D	625 12	mW mW/°C
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	PD	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

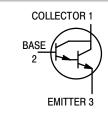
Characteristic	Symbol	Мах	Unit	
Thermal Resistance, Junction-to-Ambient	R_{\thetaJA}	200	°C/W	
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



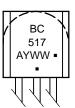
ON Semiconductor®

http://onsemi.com





MARKING DIAGRAM



A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]		
BC517	TO-92	5000 Units / Bulk		
BC517G	TO–92 (Pb–Free)	5000 Units / Bulk		
BC517RL1	TO-92	2000 / Tape & Reel		
BC517RL1G	TO–92 (Pb–Free)	2000 / Tape & Reel		
BC517ZL1	TO-92	2000 / Ammo Pack		
BC517ZL1G	TO-92 (Pb-Free)	2000 / Ammo Pack		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	·				
Collector – Emitter Breakdown Voltage $(I_C = 2.0 \text{ mAdc}, I_{BE} = 0)$	V _{(BR)CES}	30	-	-	Vdc
Collector – Base Breakdown Voltage $(I_C = 10 \ \mu Adc, I_E = 0)$	V _{(BR)CBO}	40	_	_	Vdc
Emitter – Base Breakdown Voltage $(I_E = 100 \ \mu Adc, I_C = 0)$	V _{(BR)EBO}	10	_	_	Vdc
Collector Cutoff Current (V _{CE} = 30 Vdc)	ICES	_	-	500	nAdc
Collector Cutoff Current ($V_{CB} = 30$ Vdc, $I_E = 0$)	Ісво	_	-	100	nAdc
Emitter Cutoff Current ($V_{CB} = 10 \text{ Vdc}, I_C = 0$)	I _{EBO}	_	-	100	nAdc
ON CHARACTERISTICS (Note 1)	·				
DC Current Gain (I _C = 20 mAdc, V _{CE} = 2.0 Vdc)	h _{FE}	30,000	_	_	-
Collector – Emitter Saturation Voltage $(I_C = 100 \text{ mAdc}, I_B = 0.1 \text{ mAdc})$	V _{CE(sat)}	_	_	1.0	Vdc
Collector – Emitter Saturation Voltage $(I_C = 10 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc})$	V _{BE(on)}	_	-	1.4	Vdc
SMALL-SIGNAL CHARACTERISTICS	ł				
Current–Gain – Bandwidth Product (Note 2) ($I_C = 10$ mAdc, $V_{CE} = 5.0$ Vdc, f = 100 MHz)	fT	_	200	_	MHz
				•	•

1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle 2.0%. 2. f_T = |h_{fe}| • f_{test}

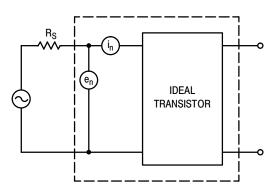
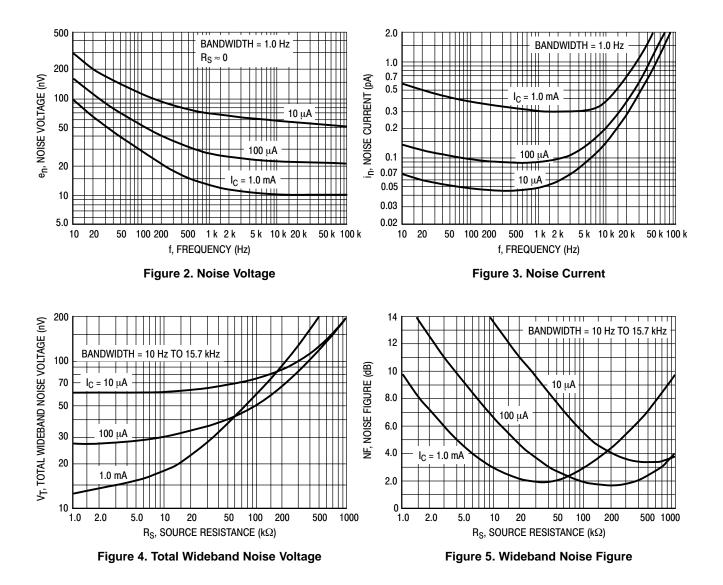


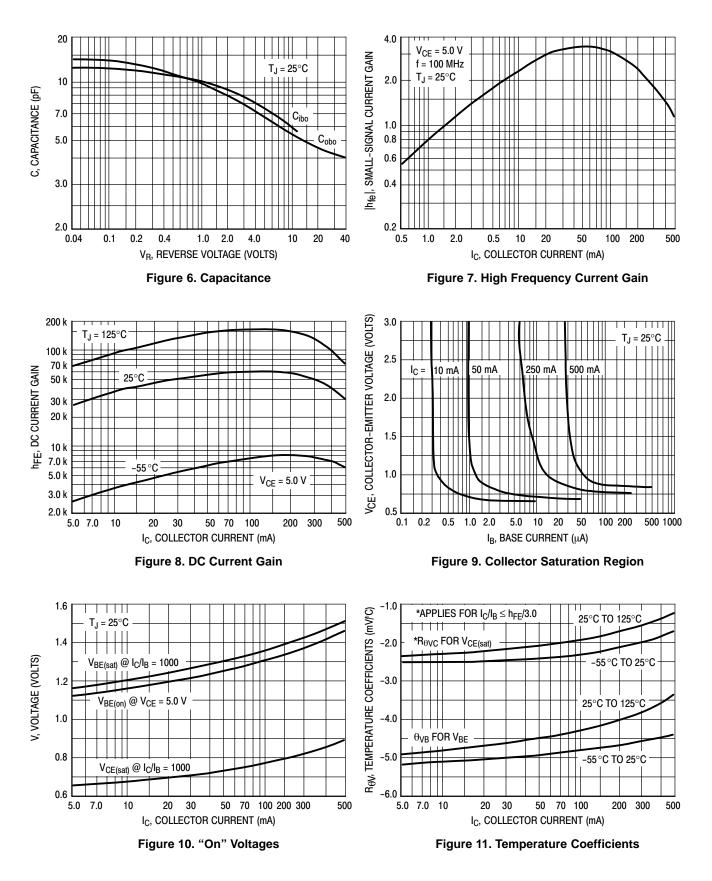
Figure 1. Transistor Noise Model

NOISE CHARACTERISTICS

(V_CE = 5.0 Vdc, T_A = 25°C)



SMALL-SIGNAL CHARACTERISTICS



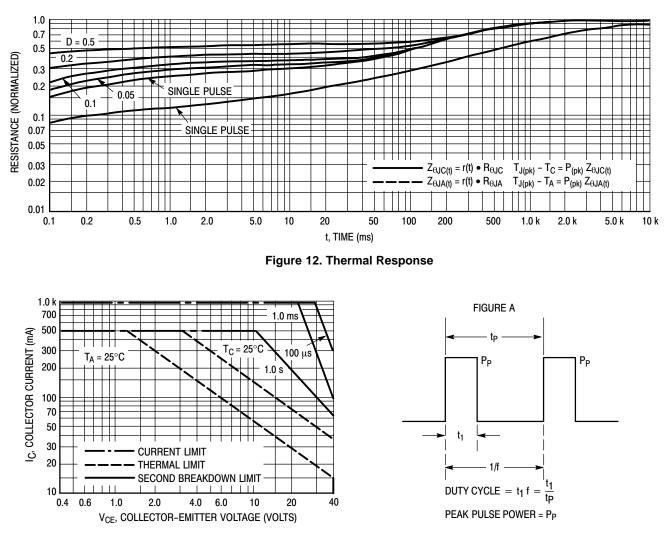
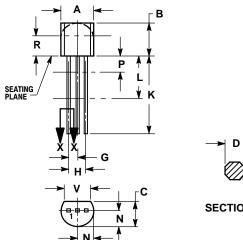


Figure 13. Active Region Safe Operating Area Design Note: Use of Transient Thermal Resistance Data

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





SECTION X-X

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

2.

CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 3.

LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
Κ	0.500		12.70	
L	0.250		6.35	
Ν	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

STYLE 17:

PIN 1. COLLECTOR 2. BASE

3. EMITTER

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